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Dated: September 27, 2007

Signature: *R. Kader*

(Rabeya S. Kader)

EXPEDITED PROCEDURE
Group Art Unit: 2814
Docket No.: TIMI 3.0-003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re. Patent Application of: :
: :
Iijima et al. :
: :
Application No.: 10/812,349 : Group Art Unit: 2814
: :
: :
Filed: March 30, 2004 : Examiner: T. X. Le
: :
: :
For: WIRING CIRCUIT BOARD, :
MANUFACTURING METHOD FOR THE :
WIRING CIRCUIT BOARD, AND :
CIRCUIT MODULE :
:

RESPONSE UNDER 37 CFR 1.116

MS AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action dated April 27, 2007,
finally rejecting claims 52-59, please amend the
above-identified U.S. patent application as follows: